

ZPMV2.E522364 - Wiring, Printed - Component

Wiring, Printed - Component

Zhuhai LieBan Electronic Technology Co.Ltd
L-shaped Workshop,3rd Floor,Plant A,Minghong Industrial Park
NO.8 Xingfu Middle Road,Hongqi Town,Jinwan District
Zhuhai, Guangdong 519090 China

E522364

Conduct Width				Max				Min					
Type	Min		Conduct	UL	Area	Solder	Assembly		Solder	Expos	Flame	Marking	Class
	mm	mm	mm	mm	mm	mm	mm	mm	mm	mm	mm	mm	mm
	mm	mm	mm	mm	mm	mm	mm	mm	mm	mm	mm	mm	mm
Multilayer printed wiring boards													
LB-3	0.075 (0.003)	0.075 (0.003)	1.2 (0.047)	25	16.2 (0.64)	255	25	-	-	150	V-0	AE	*
Single layer printed wiring boards													
LB-1	0.1 (0.004)	0.1 (0.004)	1.2 (0.047)	25	16.2 (0.64)	255	25	-	-	150	V-0	AE	*
LB-2	0.075 (0.003)	0.075 (0.003)	1.2 (0.047)	25	16.2 (0.64)	255	25	-	-	150	V-0	AE	*

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name, type designation. May be followed by a suffix to denote factory identification or burning test classification.

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